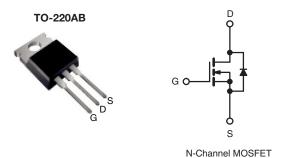
COMPLIANT

HALOGEN FREE

Vishay Siliconix

D Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	450			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	1.0		
Q _g max. (nC)	18			
Q _{gs} (nC)	3			
Q _{gd} (nC)	4			
Configuration	Single			



FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

APPLICATIONS

- Consumer Electronics
 - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies
 - SMPS
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
- Battery Chargers

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP6N40D-E3
Lead (Pb)-free and Halogen-free	SiHP6N40D-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V_{DS}	400			
Gate-Source Voltage	V _{GS}	± 30	V		
Gate-Source Voltage AC (f > 1 Hz)		30			
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	I _D	6	А	
	$T_C = 100 ^{\circ}C$		4		
Pulsed Drain Current ^a	I _{DM}	13			
Linear Derating Factor			0.8	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	104	mJ	
Maximum Power Dissipation	P_{D}	104	W		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	T _J = 125 °C	dV/dt	24	V/ns	
Reverse Diode dV/dt ^d		uv/ut	0.48	V/115	
Soldering Recommendations (Peak Temperature)	for 10 s		300°	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 2.3 \,\text{mH}$, $R_q = 25 \,\Omega$, $I_{AS} = 9.5 \,\text{A}$.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C.



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.2	C/VV

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 250 μA		0.53		V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = 250 μA		-	5	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 320 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	1 10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 3 \text{ A}$	-	0.85	1.0	Ω
Forward Transconductance	9 _{fs}		= 50 V, I _D = 3 A	_	1.7	-	S
Dynamic	313		, , , .		l	l	
Input Capacitance	C _{iss}	V 0V		-	311	_	
Output Capacitance	C _{oss}	1	$V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V},$		38	-	1
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		_	7	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{GS} = 0 V, V _{DS} = 0 V to 320 V		-	44	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	54	-	
Total Gate Charge	Qg			-	9	18	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 3 \text{ A}, V_{DS} = 320 \text{ V}$	-	3	-	nC
Gate-Drain Charge	Q _{gd}	1			4	-	1
Turn-On Delay Time	t _{d(on)}		$V_{DD} = 400 \text{ V}, I_{D} = 3 \text{ A}, \ V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		12	24	
Rise Time	t _r	Von			11	22	
Turn-Off Delay Time	t _{d(off)}				14	28	ns
Fall Time	t _f				8	16	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.9	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6	
Pulsed Diode Forward Current	I _{SM}			-	-	24	A
Diode Forward Voltage	V_{SD}	T _J = 25 °C, I _S = 3 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 3 A, dI/dt = 100 A/ μ s, V _R = 20 V		-	236	-	ns
Reverse Recovery Charge	Q _{rr}			-	1.1	-	μC
Reverse Recovery Current	I _{RRM}			-	9	-	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

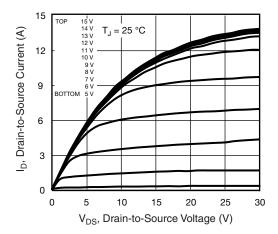


Fig. 1 - Typical Output Characteristics

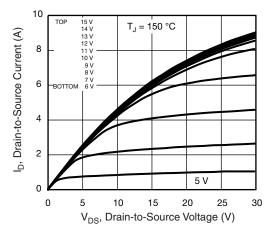


Fig. 2 - Typical Output Characteristics

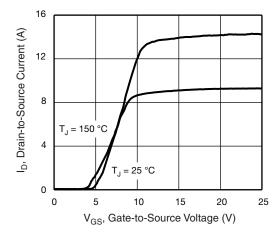


Fig. 3 - Typical Transfer Characteristics

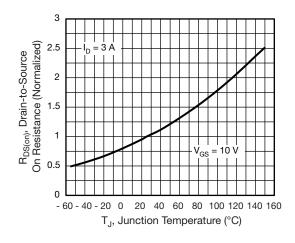


Fig. 4 - Normalized On-Resistance vs. Temperature

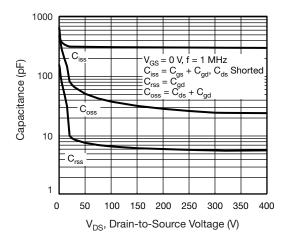


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

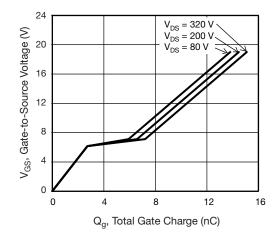


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



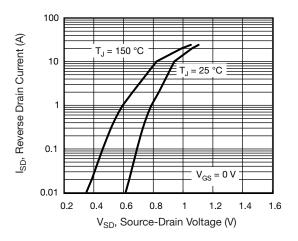


Fig. 7 - Typical Source-Drain Diode Forward Voltage

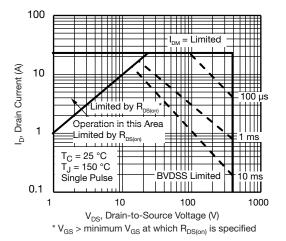


Fig. 8 - Maximum Safe Operating Area

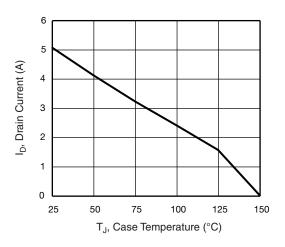


Fig. 9 - Maximum Drain Current vs. Case Temperature

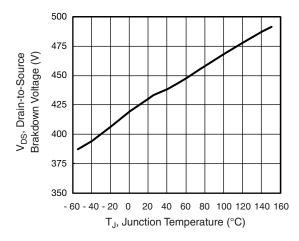


Fig. 10 - Temperature vs. Drain-to-Source Voltage

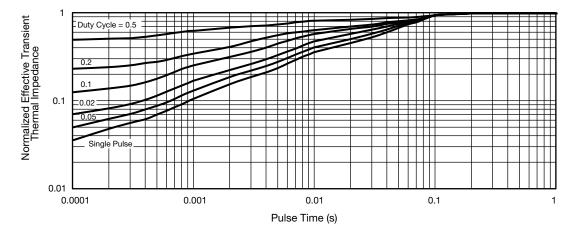


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix

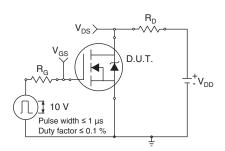


Fig. 12 - Switching Time Test Circuit

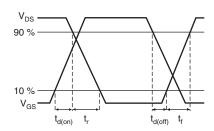


Fig. 13 - Switching Time Waveforms

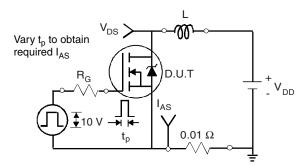


Fig. 14 - Unclamped Inductive Test Circuit

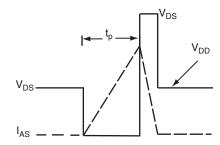


Fig. 15 - Unclamped Inductive Waveforms

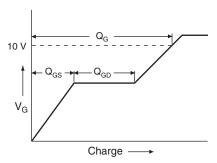


Fig. 16 - Basic Gate Charge Waveform

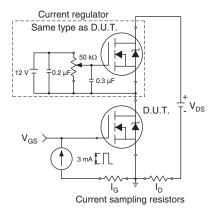
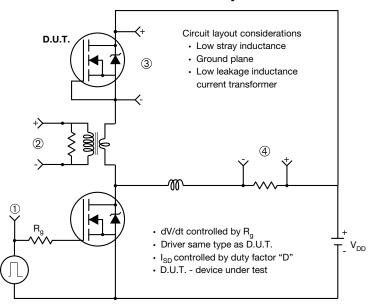


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



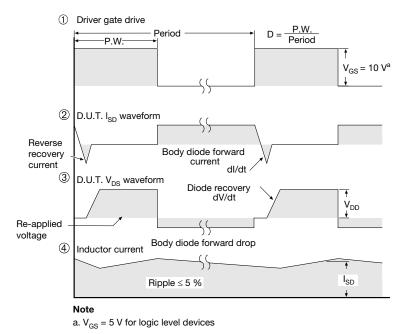


Fig. 18 - For N-Channel

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Revision: 02-Oct-12 Document Number: 91000

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